

Application Data Sheet
Application Information

Application type:: Regular
Subject matter:: Utility
CD-ROM or CD-R:: None
Number of CD disks:: 0
Number of copies of CDs:: 0
Sequence submission?:: No
Computer readable form (CRF):: No
Number of copies of CRF:: 0
Title:: Three Dimensional
Multilayer RF Module Having
Air Cavities And Method
Fabricating Same
Attorney docket number:: LEEY3017/EM
Request for early publication?:: No
Request for non-publication?:: No
Suggested drawing figure::
Total drawing sheets:: 1
Small entity?:: Small Entity

Applicant Information

Applicant authority type:: Inventor
Primary citizenship country:: Republic of Korea
Status:: Full capacity
Given name:: Young
Middle name:: Chul
Family name:: LEE
City of Residence:: Cheongju-si
Country of residence:: Korea

Street of mailing address:: Booyoung Apt. 702-509, 275
Geumcheon-dong, Sangdang-gu,
Chungcheongbuk-do

City of mailing address:: Cheongju-si

Country of mailing address:: Korea

Postal or zip code of mailing address::

Applicant Information

Applicant authority type:: Inventor

Primary citizenship country:: Republic of Korea

Status: Full capacity

Given name:: Chul

Middle name:: Soon

Family name:: PARK

City of Residence:: Daejeon

Country of residence:: Korea

Street of mailing address:: Hanul Apt. 103-402, 161
Sinseong-dong, Yuseong-gu

City of mailing address:: Daejeon

Country of mailing address:: Korea

Postal or zip code of mailing address::

Applicant Information

Applicant authority type:: Inventor

Primary citizenship country:: Republic of Korea

Status: Full capacity

Given name:: Byoung

Middle name:: Gun

Family name:: CHOI
City of Residence:: Daegu
Country of residence:: Korea

Street of mailing address:: Bokhyeonjungong Apt. 406-404,
Bokhyeon 2-dong, Buk-gu
City of mailing address:: Daegu
Country of mailing address:: Korea
Postal or zip code of mailing
address::

Applicant Information

Applicant authority type:: Inventor
Primary citizenship country:: Republic of Korea
Status: Full capacity
Given name:: Ki
Middle name:: Chan
Family name:: EUN
City of Residence:: Jeonju-si
Country of residence:: Korea

Street of mailing address:: Gwangjin Jinju Apt. 2-408,
Hyoja-dong, Wansan-gu,
Jeollabuk-do
City of mailing address:: Jeonju-si
Country of mailing address:: Korea
Postal or zip code of mailing
address::

Applicant Information

Applicant authority type:: Inventor

Primary citizenship country:: Republic of Korea
Status: Full capacity
Given name:: Dae
Middle name:: Jun
Family name:: KIM
City of Residence:: Seoul
Country of residence:: Korea

Street of mailing address:: 168-4 Poi-dong, Gangnam-gu
City of mailing address:: Seoul
Country of mailing address:: Korea
Postal or zip code of mailing address::

Correspondence Information

Correspondence customer number:: 23364
Phone number:: 703-683-0500
Fax number:: 703-683-1080
E-mail address:: mail@baonthomas.com

Representative Information

Representative customer number:: 23364

Domestic Priority Information

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority claimed::
Korea	2002-47543	08/12/02	YES

Assignee Information

Assignee name:: Information and Communications University Educational Foundation

Street of mailing address:: 10th Fl., Seoul Central Post
Office Bldg., 21 Chungmuro 1-Ga,
Jung-Gu

City of mailing address:: Seoul

Country of mailing address:: Korea

Postal or zip code of
mailing address:: 100-709